

* Drain current limited by maximum junction temperature.



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC I	PARAMETERS	·				
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250µA, V _{GS} =0V, T _J =25°C	600			
		I_D =250µA, V_{GS} =0V, T_J =150°C		700		V
BV _{DSS} /∆TJ	Breakdown Voltage Temperature Coefficient	I _D =250μΑ, V _{GS} =0V		0.65		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} =600V, V_{GS} =0V			1	μA
		V_{DS} =480V, T_{J} =125°C			10	
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±30V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V_{DS} =5V I_{D} =250 μ A	3	4	4.5	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =5A		0.6	0.75	Ω
g _{FS}	Forward Transconductance	V_{DS} =40V, I_{D} =5A		15		S
V _{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.73	1	V
I _S	Maximum Body-Diode Continuous Current				10	А
I _{SM}	Maximum Body-Diode Pulsed Current				36	Α
DYNAMI	C PARAMETERS					
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =25V, f=1MHz	1100	1320	1600	рF
C _{oss}	Output Capacitance		105	130	160	pF
C _{rss}	Reverse Transfer Capacitance		7.5	9.3	11	pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	3	3.8	6	Ω
SWITCH	NG PARAMETERS					
Qg	Total Gate Charge	V _{GS} =10V, V _{DS} =480V, I _D =10A		31	40	nC
Q _{gs}	Gate Source Charge			6	10	nC
Q _{gd}	Gate Drain Charge			14.4	20	nC
t _{D(on)}	Turn-On DelayTime			28	35	ns
t _r	Turn-On Rise Time	V _{GS} =10V, V _{DS} =300V, I _D =10A,		66	80	ns
t _{D(off)}	Turn-Off DelayTime	$R_G=25\Omega$		76	95	ns
t _f	Turn-Off Fall Time	7		64	80	ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =10A,dI/dt=100A/μs,V _{DS} =100V		290	350	ns
Q _{rr}	Body Diode Reverse Recovery Charge	_e I _F =10A,dI/dt=100A/μs,V _{DS} =100V		3.9	4.7	μC

A. The value of R_{0JA} is measured with the device in a still air environment with $T_A = 25^{\circ}$ C.

B. The power dissipation P_{D} is based on $T_{J(MAX)}=150^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}=150^{\circ}$ C, Ratings are based on low frequency and duty cycles to keep initial $T_{J}=25^{\circ}$ C.

D. The R _{BJA} is the sum of the thermal impedence from junction to case R _{BJC} and case to ambient.

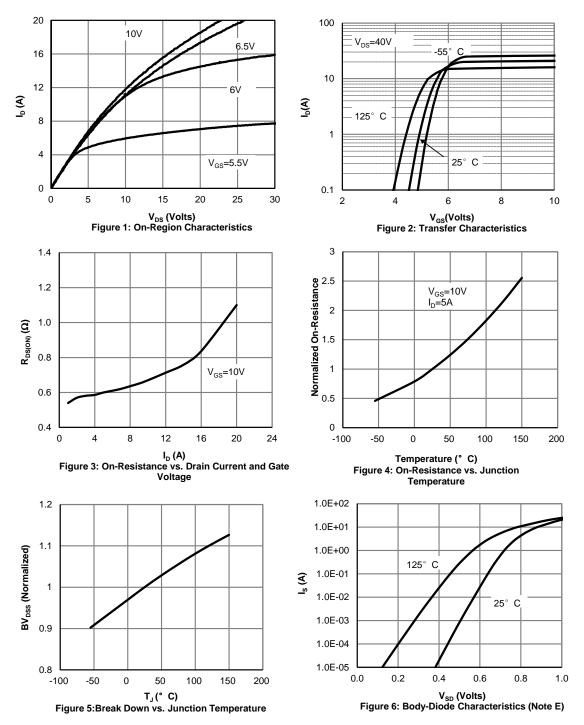
E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max. F. These curves are based on the junction-to-case thermal impedence which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX]}=150° C. The SOA curve provides a single pulse rating. G. L=60mH, I_{AS}=4.4A, V_{DD}=150V, R_G=25 Ω , Starting T_J=25° C

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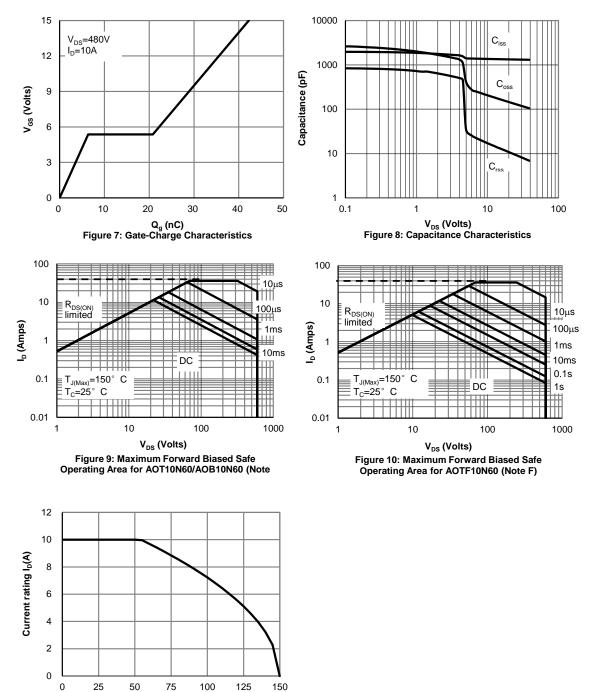
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





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T_{CASE} (°C) Figure 11: Current De-rating (Note B)





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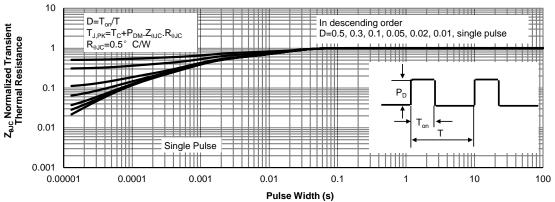
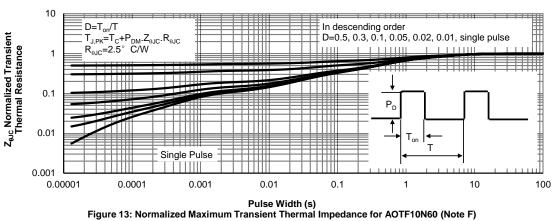
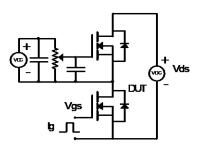


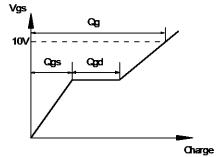
Figure 12: Normalized Maximum Transient Thermal Impedance for AOT10N60/AOB10N60 (Note F)



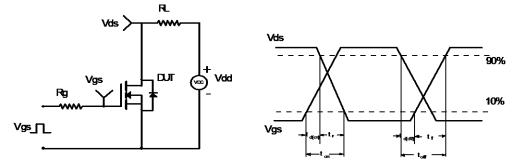


Gate Charge Test Circuit & Waveform

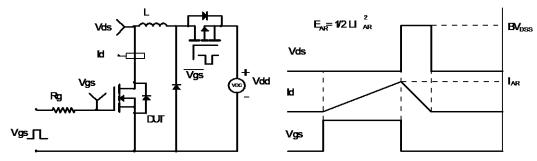




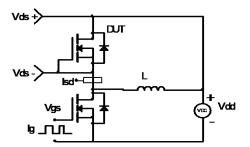
Resistive Switching Test Circuit & Waveforms

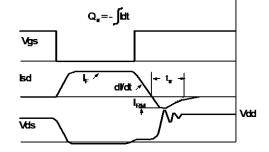


Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms





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